



Features



HIGH SURGE TVS DIODE

Product Summary

V _{BR (Min)}	I _{PP (Max)}	C _{T (Typ)}
6.2V	40A	210pF

1 Channel of ESD Protection

Portable Electronics

Contact ±30kV

- Low Channel Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)

Low Profile Package (0.53mm Max) and Ultra-Small PCB Footprint Area (1.08mm * 0.68mm Max) Suitable for Compact

Provides ESD Protection per IEC 61000-4-2 Standard: Air ±30kV,

- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Description and Applications

This new generation TVS is designed to protect sensitive electronics from the damage due to ESD. The combination of small size and high ESD surge capability makes it ideal for use in Automotive Infotainment applications including,

- USB Modules
- HDMI Inputs
- Infotainment Console

Mechanical Data

- Case: X1-DFN1006-2
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.001 grams (Approximate)

X1-DFN1006-2



Bottom View



Device Schematic

Ordering Information (Note 4)

Part Number	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity Per Reel
D5V0S1U2LP-7B	Standard	S2	7	8	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- $4. For packaging details, go to our website at \ https://www.diodes.com/design/support/packaging/diodes-packaging/. \\$

Marking Information



S2 = Product Type Marking Code Bar Denotes Pin 1 or Cathode Side

D5V0S1U2LP
Document number: DS40991 Rev. 1 - 2
Downloaded from Arrow.com.



Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P_PP	500	W	8/20µs, per Figure 3
Peak Pulse Current	I _{PP}	40	Α	8/20µs, per Figure 3
ESD Protection – Contact Discharge	V _{ESD_CONTACT}	±30	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	V _{ESD_AIR}	±30	kV	IEC 61000-4-2 Standard

Thermal Characteristics

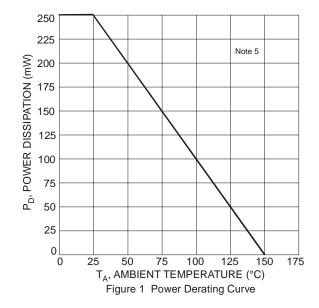
Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P_{D}	250	mW
Thermal Resistance, Junction to Ambient (Note 6)	$R_{ heta JA}$	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

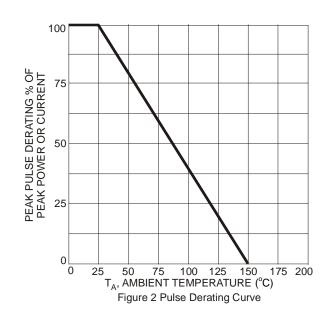
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Working Voltage	V_{RWM}	_	_	5.5	V	_
Reverse Current (Note 6)	I _R	_	0.1	1.0	μA	$V_R = V_{RWM} = 5.0V$
Reverse Breakdown Voltage	V_{BR}	6.2	_	7.4	V	I _R = 1mA
	V _{CL}	1	_	8.0	V	$I_{PP} = 5A$, $t_p = 8/20\mu s$
Reverse Clamping Voltage		1	_	11.5		$I_{PP} = 30A, t_p = 8/20\mu s$
			_	13.0		$I_{PP} = 40A, t_p = 8/20\mu s$
Capacitance	C _T	_	210	_	pF	$V_R = 0V$, $f = 1MHz$

Notes:

^{6.} Short duration pulse test used to minimize self-heating effect.





^{5.} Device mounted on FR-4 PCB pad layout (2oz copper) as shown in Diodes Incorporated's package outline PDFs, which can be found on our website at http://www.diodes.com/package-outlines.html.





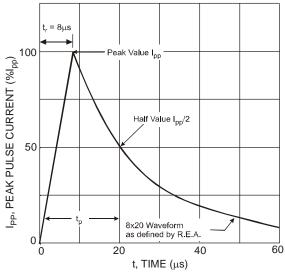
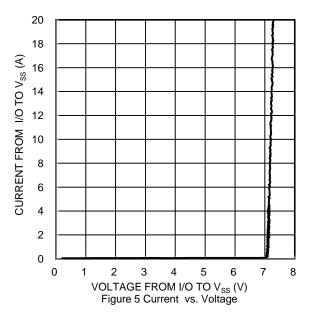
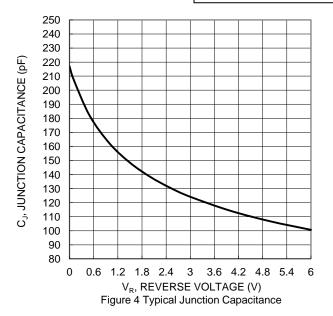
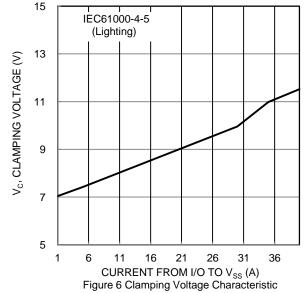


Figure 3 Typical 8 x 20µs Pulse Waveform





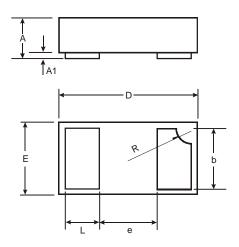




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X1-DFN1006-2

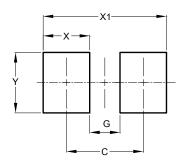


X1-DFN1006-2					
Dim	Min	Max	Тур		
Α	0.47	0.53	0.50		
A1	0	0.05	0.03		
b	0.45	0.55	0.50		
D	0.95	1.075	1.00		
Е	0.55	0.675	0.60		
е	-	-	0.40		
L	0.20	0.30	0.25		
R	0.05	0.15	0.10		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X1-DFN1006-2



Dimensions	Value (in mm)	
С	0.70	
G	0.30	
Х	0.40	
X1	1.10	
Υ	0.70	



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